The RF Line

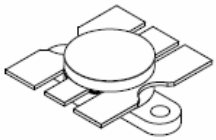
NPN Silicon RF Power Transistor

Designed for 12.5 Volt UHF large–signal, common emitter, class–C amplifier applications in industrial and commercial FM equipment operating to 520 MHz.

- Specified 12.5 Volt, 512 MHz Characteristics
  - Output Power = 65 Watts
  - Minimum Gain = 4.15 dB
  - Minimum Efficiency = 50%
- Characterized with Series Equivalent Large–Signal Impedance Parameters from 400 to 520 MHz
- Built–In Matching Network for Broadband Operation
- Triple Ion Implanted for More Consistent Characteristics
- Implanted Emitter Ballast Resistors for Improved Ruggedness
- Silicon Nitride Passivated
- Capable of Surviving Load Mismatch Stress at all Phase Angles with 20:1 VSWR @ 15.5 Vdc and 2.0 dB Overdrive

MRF658

65 W, 512 MHz
RF POWER TRANSISTOR
NPN SILICON



CASE 316–01, STYLE 1

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	16.5	Vdc
Collector–Emitter Voltage	V_{CES}	38	Vdc
Emitter–Base Voltage	V_{EBO}	4.0	Vdc
Collector Current — Continuous	I_C	15	Adc
Total Device Dissipation @ T_C = 25°C Derate above 25°C	P_D	175 1.0	Watts W/°C
Storage Temperature Range	T_{stg}	– 65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.0	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Breakdown Voltage (I_C = 50 mAdc, I_B = 0)	$V_{(BR)CEO}$	16.5	29	—	Vdc
Collector–Emitter Breakdown Voltage (I_C = 50 mAdc, V_{BE} = 0)	$V_{(BR)CES}$	38	45	—	Vdc
Emitter–Base Breakdown Voltage (I_E = 10 mAdc, I_C = 0)	$V_{(BR)EBO}$	4.0	4.6	—	Vdc
Collector Cutoff Current (V_{CE} = 15 Vdc, V_{BE} = 0, T_C = 25°C)	I_{CES}	—	0.1	10	mAdc